Product Summary

V _{(BR)DSS}	$R_{DS(on)TYP}$	I_D
250V	18mΩ@10V	60A



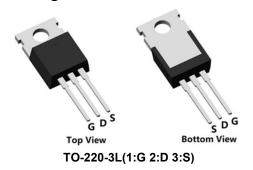
Feature

- Fast Switching
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

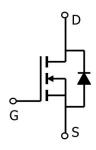
Applications

- PWM Application
- Hard switched and high frequency circuits
- Power Management

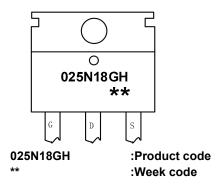
Package



Circuit diagram



Marking



Order Information

Device	Package	Unit/Tube		
SP025N18GHTQ	TO-220-3L	50		



250V N-Channel Power MOSFET

Absolute maximum ratings (Ta=25°C,unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V _{DS}	250	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current (Tc=25°C)	I _D	60	А
Continuous Drain Current (Tc=100°C)	I _D	40	А
Pulsed Drain Current	Ідм	240	А
Single Pulse Avalanche Energy ¹	E _{AS}	841	mJ
Power Dissipation (Tc=25°C)	P _D	280	W
Thermal Resistance Junction-to-Case	Rejc	0.45	°C/W
Storage Temperature Range	T _{STG}	-55 to 150	$^{\circ}$
Operating Junction Temperature Range	TJ	-55 to 150	$^{\circ}$ C

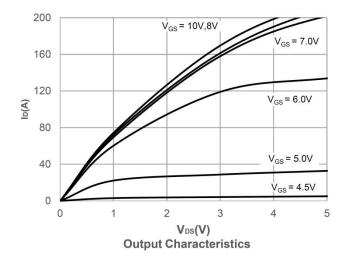
Electrical characteristics (Ta=25°C, unless otherwise noted)

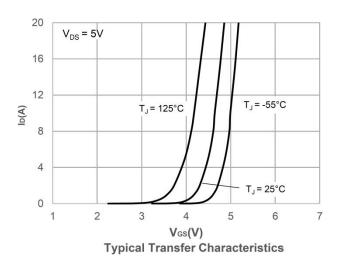
Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	VGS=0V , ID=250uA	250	-	-	V
Drain Cut-Off Current	I _{DSS}	VDS=200V , VGS=0V , TJ=25 $^{\circ}\mathrm{C}$	-	-	1	μA
Gate Leakage Current	I _{GSS}	VGS=±20V , VDS=0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	VGS=VDS , ID =250uA	2.5	3.5	4.5	V
Drain-Source ON Resistance	R _{DS(ON)}	VGS=10V, ID=20A	-	18	23	mΩ
Dynamic Characteristics						
Input Capacitance	C _{iss}		-	9824	-	
Output Capacitance	Coss	VDS=125V , VGS=0V , f=1MHz	-	290	-	pF
Reverse Transfer Capacitance	C _{rss}		-	18	-	
Total Gate Charge	Qg		-	70	-	nC
Gate-Source Charge	Q _{gs}	VDS=125V , VGS=10V , ID=20A	-	24	-	
Gate-Drain Charge	Q_{gd}		-	22	-	
Switching Characteristics					•	
Turn-On Delay Time	t _{d(on)}		-	33	-	
Rise Time	tr	VDD=125V , VGS=10V , RG=10Ω	-	15	-	
Turn-Off Delay Time	t _{d(off)}	ID=20A	-	61	-	nS
Fall Time	t _f		-	8	-	
Drain-Source Body Diode Characteri	stics					
Source-Drain Diode Forward Voltage	V _{SD}	VGS=0V , IS=1A , TJ=25℃	-	-	1.2	V
Maximum Body-Diode Continuous Current	Is		-	-	60	Α
Reverse Recovery Time	Trr	IC-204 di/dt-2004/ T1 25%		168	-	nS
Reverse Recovery Charge	Qrr	IS=20A, di/dt=200A/us, TJ=25℃	-	795	-	nC

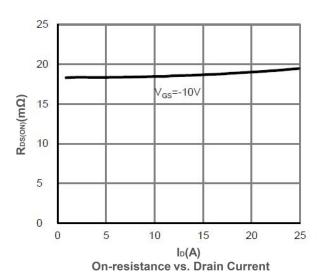
Note:

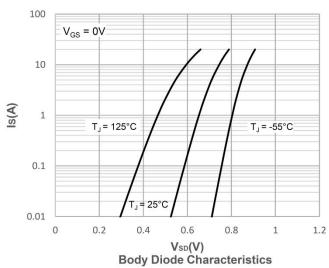
1. The test condition is VDD=75V,VGS=10V,L=0.5mH,RG=25 Ω

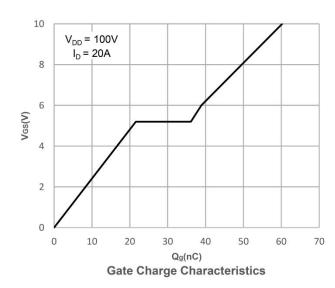
Typical Characteristics

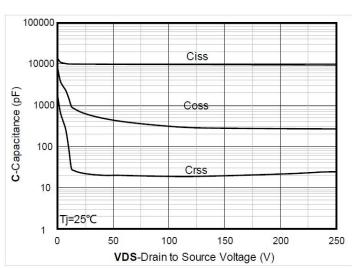






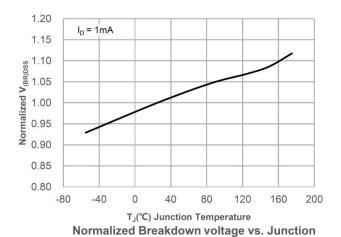




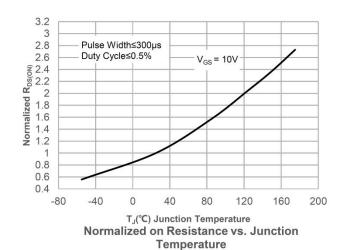


Capacitance Characteristics





Temperature

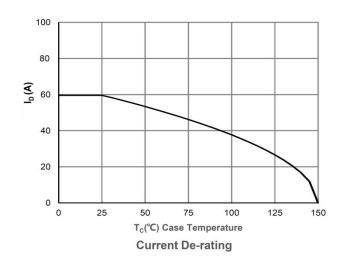


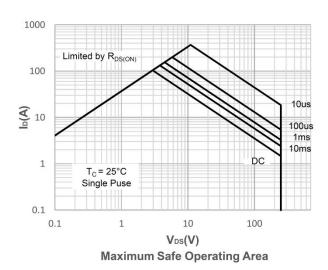
1.4 1.2 V_{DS} = V_{GS} I_D = 250uA 0.8 0.6 0.4 0.2 -80 -40 0 40 80 120 160 200

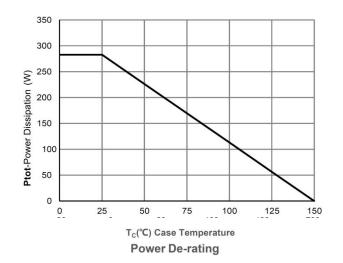
 $T_J(^{\circ}C)$ Junction Temperature

Normalized Threshold Voltage vs. Junction

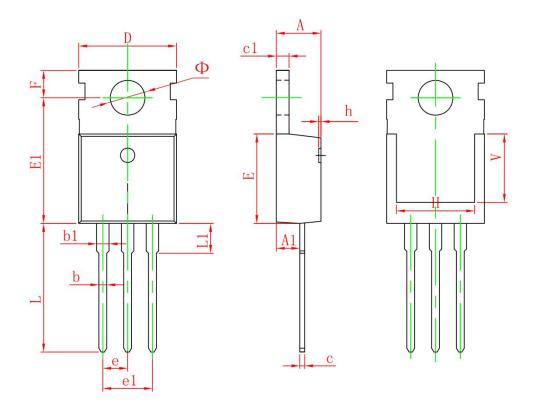
Temperature







TO-220-3L Package Information



Symbol	Dimensions In Millimeters		Dimension	Dimensions In Inches	
	Min.	Max.	Min.	Max.	
Α	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.950	9.750	0.352	0.384	
E1	12.650	13.050	0.498	0.514	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	6.900 REF.		0.276	REF.	
Φ	3.400	3.800	0.134	0.150	